## RENESAS

## HD74LS157

# Quadruple 2-line-to-1-line Data Selectors / Multiplexers (noninverted outputs)

REJ03D0442-0200 Rev.2.00 Feb.18.2005

This data selector / multiplexer contains inverters and drivers to supply full on-chip data selection to the four output gates. A separate strobe input is provided. A 4-bit word is selected from one of two sources and is routed to the four outputs. Then, outputs present true data to minimize propagation delay time.

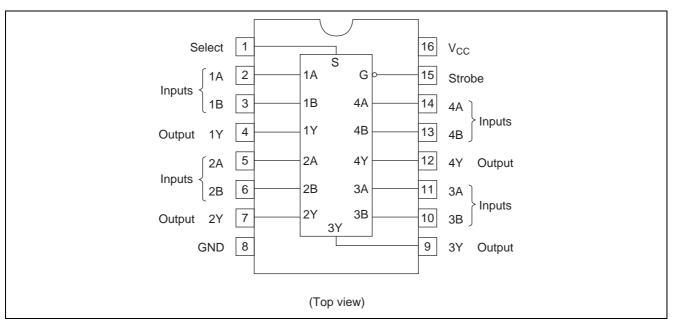
### Features

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)	
HD74LS157P	DILP-16 pin	PRDP0016AE-B (DP-16FV)	Р	—	
HD74LS157FPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)	
HD74LS157RPEL	SOP-16 pin (JEDEC)	PRSP0016DG-A (FP-16DNV)	RP	EL (2,500 pcs/reel)	

Note: Please consult the sales office for the above package availability.

### **Pin Arrangement**



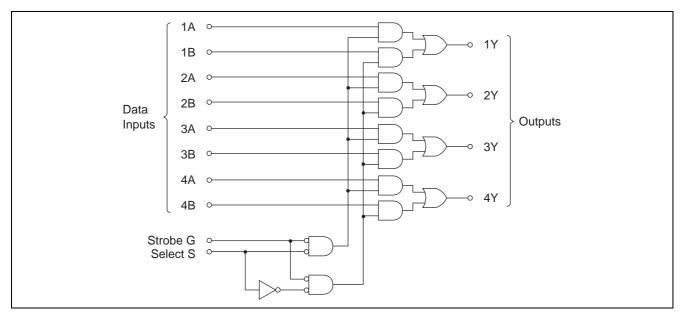


#### **Function Table**

	Inputs						
Strobe	Select	Y					
Н	Х	Х	Х	L			
L	L	L	Х	L			
L	L	Н	Х	Н			
L	Н	Х	L	L			
L	Н	Х	Н	Н			

H; high level, L; low level, X; irrelevant

### **Block Diagram**



#### **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit	
Supply voltage	V <sub>CC</sub>	7	V	
Input voltage	V <sub>IN</sub>	7	V	
Power dissipation	PT	400	mW	
Storage temperature	Tstg	-65 to +150	°C	

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

### **Recommended Operating Conditions**

Item	Symbol	Min	Тур	Max	Unit
Supply voltage	V <sub>CC</sub>	4.75	5.00	5.25	V
Output current	I <sub>OH</sub>	—	—	-400	μΑ
Output current	I <sub>OL</sub>	—	—	8	mA
Operating temperature	Topr	-20	25	75	°C



### **Electrical Characteristics**

ltem		Symbol	min.	typ.*	max.	Unit	Condition		
Input voltage		V <sub>IH</sub>	2.0	_	_	V			
		V <sub>IL</sub>	—		0.8	V			
		V <sub>OH</sub>	2.7		_	V	$\label{eq:Vcc} \begin{array}{l} V_{CC} = 4.75 \ V, \ V_{IH} = 2 \ V, \ V_{IL} = 0.8 \ V, \\ I_{OH} = -400 \ \mu A \end{array}$		
Output voltage		M	_		0.4	V	$I_{OL} = 4 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, V_{IH} = 2 \text{ V},$		
		V <sub>OL</sub>	_	_	0.5	V	I <sub>OL</sub> = 8 mA V <sub>IL</sub> = 0.8 V		
	S, G	- I <sub>IH</sub>	_	_	40	μA	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 2.7 \text{ V}$		
	А, В		_	_	20				
loout ourroot	S, G		_		-0.8	~ ^	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 0.4 \text{ V}$		
Input current	А, В	IIL	_	_	-0.4	mA			
	S, G	1	_	—	0.2	mA	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 7 \text{ V}$		
	А, В	I,		—	0.1	ША			
Short-circuit output current		los	-20	_	-100	mA	V <sub>CC</sub> = 5.25 V		
Supply current**		Icc	—	9.7	16	mA	V <sub>CC</sub> = 5.25 V		
Input clamp voltage		VIK	_		-1.5	V	$V_{CC} = 4.75 \text{ V}, I_{IN} = -18 \text{ mA}$		

Notes: \*  $V_{CC}$  = 5 V, Ta = 25°C

 $^{\ast\ast}$  I\_{CC} is measured with all outputs open and all inputs at 4.5 V.

### **Switching Characteristics**

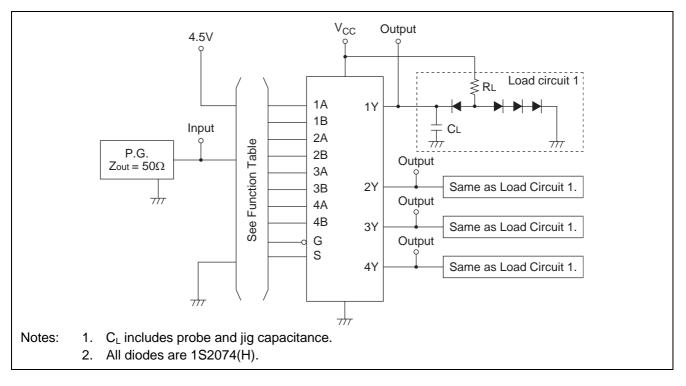
 $(V_{CC} = 5 V, Ta = 25^{\circ}C)$ 

Item	Symbol	Inputs	Output	min.	typ.	max.	Unit	Condition
Propagation delay time	t <sub>PLH</sub>	Data	Y	Ι	9	14	ns	- C <sub>L</sub> = 15 pF, R <sub>L</sub> = 2 kΩ
	t <sub>PHL</sub>				9	14	ns	
	t <sub>PLH</sub>	Strobe	Y		13	20	ns	
	t <sub>PHL</sub>			Ι	14	21	ns	
	t <sub>PLH</sub>	Select	Y	Ι	15	23	ns	
	t <sub>PHL</sub>			_	18	27	ns	

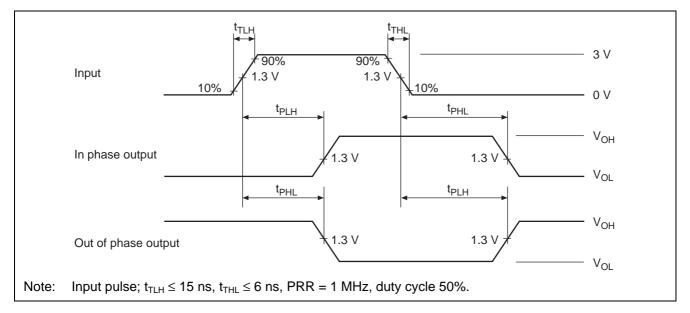


### **Testing Method**

#### **Test Circuit**

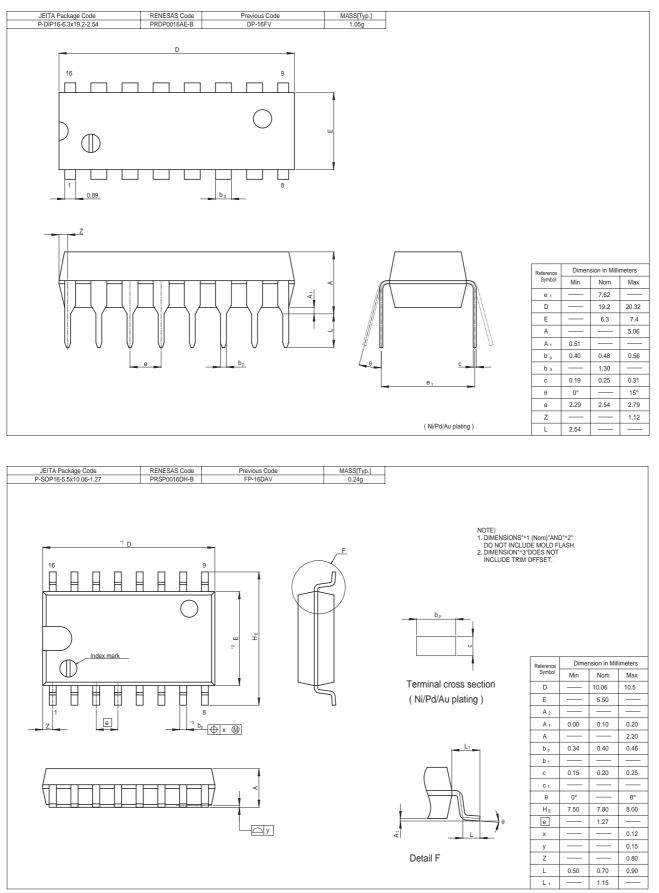


#### Waveform



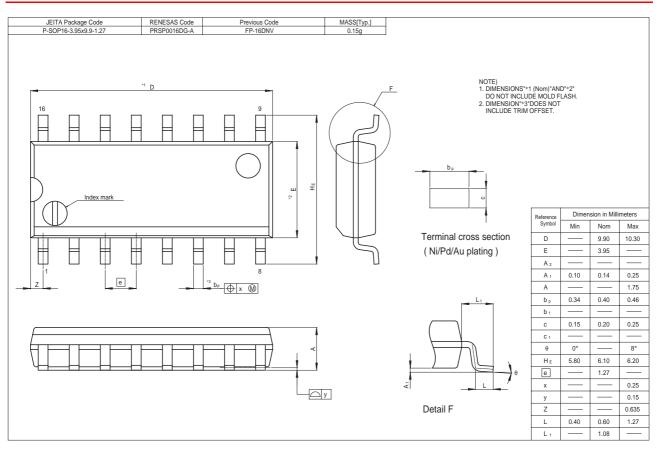


### **Package Dimensions**





#### HD74LS157





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